

NATIONAL INSTITUTE OF AEROSPACE

High Fidelity Topographical Modification of Materials for Lunar Dust Adhesion Mitigation

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Christopher J. Wohl¹, Marcus A. Belcher¹, Yi Lin¹, John W. Connell² National institute of Aerospace, Hampton, VA 23666-6147 NASA Langley Research Center, Hampton, VA 23681-2199



The Lunar Dust Problem ... Briefly

The lunar dust is problematic due to its:

- High porosity
- Broad size distribution
- Health risks
- Instrument and equipment compromising capability
- Potentially dynamic state

The lunar dust is **Strongly Adhesive** due to:

- Mechanical interlocking
- Electrostatic charging
- Magnetic properties
- Chemical reactivity



Bell, T., "True-Grit"-Unearthly Dust. *The Bent of Tau Beta Pi* 2006, pp 14 – 16.

Surface Energy vs. Adhesion: Working Hypothesis



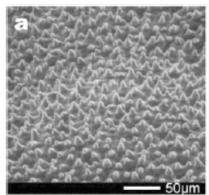


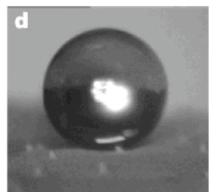
Intrinsic Lunar Dust Adhesive Interactions













Langmuir **2005**, 21, 8978.

Lunar Dust Simulant Mitigation Strategies



Objective:

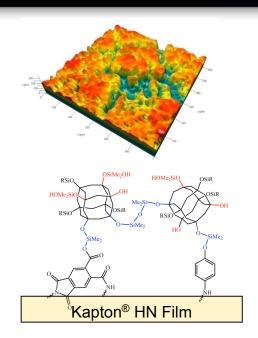
- Develop a more fundamental understanding of the effects of surface energy and topography on lunar dust simulant adhesion
- Research surface energy modification methods which are applicable to a diverse array of existing and experimental materials

Approach:

- Utilize topographical modification techniques and low surface energy materials to introduce lotus-effect surface properties
- Adhere lunar dust simulant particles to AFM cantilevers and measure the work of adhesion on various surface treatments
- Evaluate the efficacy of surface treatments for adhesion mitigation
 through active particle detachment experiments



Comparison of Topography Fidelity



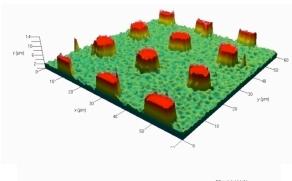


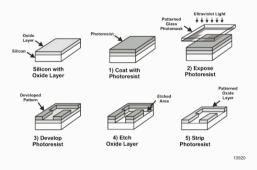


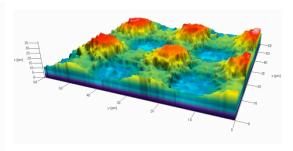
Appl. Surf. Sci. **2009**, 255(18), 8135-8144.

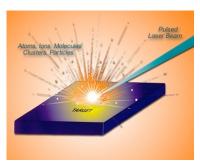


Low Fidelity









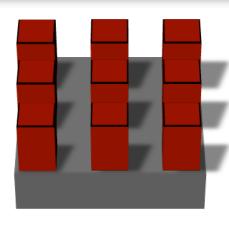
Photolithography

Laser Ablation Patterning

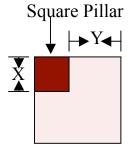
High Fidelity

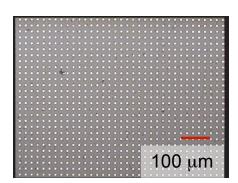
Surface Engineering Question: What Dimensions Should be Used?

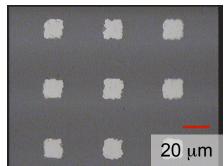




| Mask # | Photomask dimensions (mm) | | Photomask area (mm²) | | Solid-liquid interface |
|--------|---------------------------|----|-------------------------|---------------|---------------------------|
| | Х | Y | area | "Pillar" area | fraction |
| 1 | 20 | 25 | 2025 | 400 | 0.20 |
| 2 | 20 | 40 | 3600 | 400 | 0.11 |
| 3 | 20 | 10 | 900 | 400 | 0.44 |
| 4 | 10 | 10 | 400 | 100 | 0.25 |

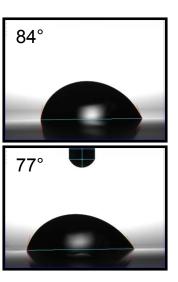






Flat Ni-coated Kapton

Ni-coated Kapton w/ Photopattern #1



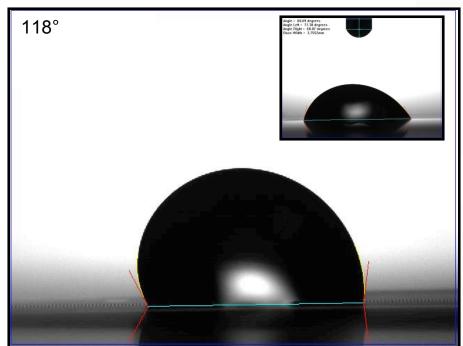


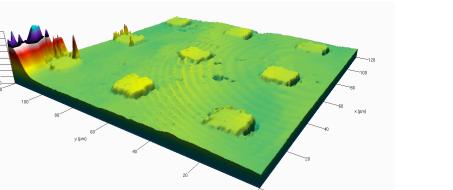
Photolithography Series I: Ni-coated Kapton®



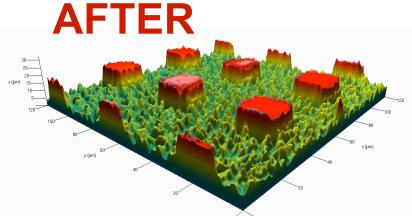
Exposure to CF₄ plasma deposits a Teflon®-like layer while increasing

the pillar depth





BEFORE





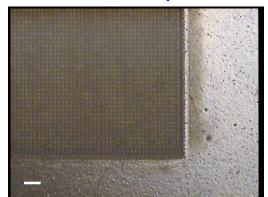
Feature size~ 20 μm

Feature size ~ 0.4 μm

Laser Ablation Pattern Visualization: Optical and Confocal Microscopy



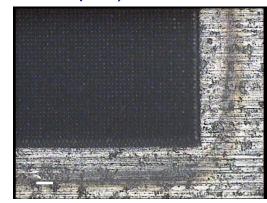
Optical Microscope Images (Scale Bar: 100 μm)







Polyimide Siloxane



Aluminum 3003H14

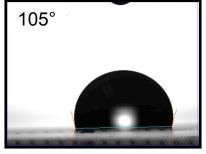
Confocal Microscope Images 15 μm 25 μm 25 μm

Feature sizes



Laser Ablation of Commercial Materials

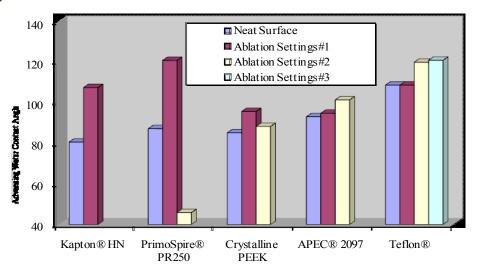
 Laser ablation patterning lowers the surface energy of materials as shown by increasing water contact angles.



yimide Siloxane After

176°

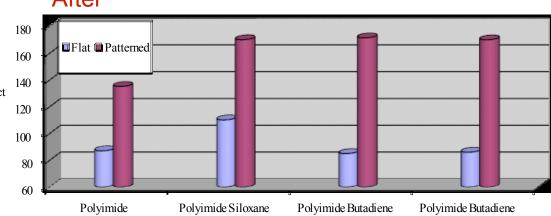
Laser Ablation Patterning of Commercially Available Materials



Acrylonitrile

Polyimide Siloxane Before

Advancing Water Contact Angle





Qualitative Dust Adhesion Testing: Crude Tapping Test



 Lunar dust simulant (≤ 25 μm) was deposited on the surface. The samples were then tilted 90° and tapped once on a hard surface. (50 times magnification)











Before

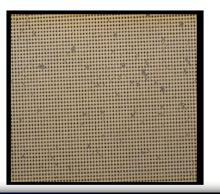


Patterned Aluminum 3003H14





After





Dust Adhesion Testing: AFM Adhesion Force Measurement



AFM Adhesion Test

Sonic Wand Test

- Largest individual grains ≈ 3 μm
- Spherical particle volume = $4/3\pi r^3 = 14.2 \mu m^3$
- Particle Mass (SG of 2.9 g/cm³) = 41 pg
- Surface acceleration was 4.08*10⁵ m/s²
- Minimal adhesion force for the remaining particles of 16.7 nN.
- The adhesion of:
 - Seasoning to a tortilla chip = 1.6 330 nN
 - Silicon nitride AFM tip to tantalum oxynitride = 3 nN
 - ITO-coated AFM tip to CF³-functionalized Si wafer = 25 nN



Image Magnified 200 times



Conclusions

- No single material, surface preparation, or device will be amenable to every lunar application.
- Surface chemistry and topographical modifications are effective means to tailor materials with specific interfacial properties.
- Laser ablation patterning is a rapid, scalable, high precision technique for engineering surface topographies and is applicable to a wide variety of materials.
- It is important to develop an efficient screening tool towards identifying the efficacy of materials and surface treatments on lunar dust simulant adhesion.
- Our passive approach coupled with active lunar dust mitigation strategies may be advantageous for some applications and is currently under investigation.



Acknowledgements

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